Photocouplers Photorelay

TLP3109

1. Applications

- Mechanical relay replacements
- Security Systems
- Measuring Instruments
- Factory Automation (FA)
- Amusement Equipment

2. General

The TLP3109 photorelay consists of a photo MOSFET optically coupled to an infrared LED. It is housed in a 2.54SOP6 package. The low ON-state resistance and the high permissible ON-state current of the TLP3109 make it suitable for power line control applications.

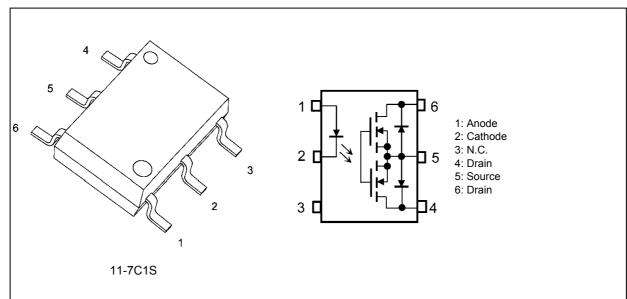
3. Features

- (1) Normally opened (1-Form-A)
- (2) OFF-state output terminal voltage: 100 V (min)
- (3) Trigger LED current: 3 mA (max)
- (4) ON-state current: 2.0 A (max) (A connection)
- (5) ON-state resistance: 70 m Ω (max) (A connection)
- (6) Isolation voltage: 1500 Vrms (min)
- (7) Safety standards

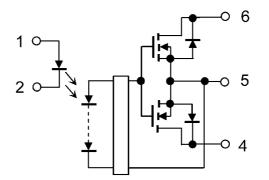
UL-recognized: UL 1577, File No.E67349

cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349

4. Packaging and Pin Assignment



5. Internal Circuit



6. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

	Characteristics	Symbol	Note	Rating	Unit	
LED	Input forward current		I _F		30	mA
	Input forward current derating	$(T_a \ge 25 \ ^\circ C)$	$\Delta I_F / \Delta T_a$		-0.3	mA/°C
	Input forward current (pulsed)	(100 µs pulse, 100 pps)	I _{FP}		1	A
	Input reverse voltage		V _R		5	V
	Input power dissipation		PD		50	mW
	Input power dissipation derating	(T _a ≥ 25 °C)	$\Delta P_D / \Delta T_a$		-0.5	mW/°C
	Junction temperature		Тj		125	°C
Detector	OFF-state output terminal voltage		V _{OFF}		100	V
	ON-state current (A connection)	I _{ON}	(Note 1)	2.0	A	
	ON-state current (B connection)	I _{ON}	(Note 1)	2.0		
	ON-state current (C connection)		I _{ON}	(Note 1)	4.0	
	ON-state current derating (A connection)	(T _a ≥ 25 °C)	$\Delta I_{ON} / \Delta T_a$	(Note 1)	-20	mA/°C
	ON-state current derating (B connection)	$(T_a \ge 25 \ ^\circ C)$	$\Delta I_{ON} / \Delta T_a$	(Note 1)	-20	
	ON-state current derating (C connection)	$(T_a \ge 25 \ ^\circ C)$	$\Delta I_{ON} / \Delta T_a$	(Note 1)	-40	
	ON-state current (pulsed)	(t = 100 ms, Duty = 1/10)	I _{ONP}		6	А
	Output power dissipation		Po		400	mW
	Output power dissipation derating	(T _a ≥ 25 °C)	$\Delta P_0 / \Delta T_a$		-4.0	mW/°C
	Junction temperature		Тj		125	°C
Common	Storage temperature		T _{stg}		-55 to 125	
	Operating temperature		T _{opr}		-40 to 85]
	Lead soldering temperature	(10 s)	T _{sol}		260]
	Isolation voltage	AC, 60 s, R.H. \leq 60 %	BV _S	(Note 2)	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: For an application circuit example, see Chapter 12.2.

Note 2: This device is considered as a two-terminal device: Pins 1, 2 and 3 are shorted together, and pins 4, 5 and 6 are shorted together.

7. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Тур.	Max	Unit
Supply voltage	V _{DD}		_	—	80	V
Input forward current	١ _F		5	10	25	mA
ON-state current (A connection)	I _{ON}		_	_	2.0	А
Operating temperature	T _{opr}		-20	_	65	°C

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this data sheet should also be considered.

8. Electrical Characteristics (Unless otherwise specified, $T_a = 25$ °C)

	Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
LED	Input forward voltage	V _F		I _F = 10 mA	1.18	1.33	1.48	V
	Input reverse current	I _R		V _R = 5 V			10	μA
	Input capacitance	Ct		V = 0 V, f = 1 MHz	_	70	—	pF
Detector	OFF-state current	I _{OFF}		V _{OFF} = 100 V	_	—	1	μA
				V _{OFF} = 80 V	_	_	20	nA
	Output capacitance	C _{OFF}		V = 0 V, f = 1 MHz		500		pF

9. Coupled Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}		I _{ON} = 100 mA	—	0.4	3	mA
Return LED current	I _{FC}		I _{OFF} = 10 μA	0.1	—	_	
ON-state resistance (A connection)	R _{ON}	(Note 1)	I _{ON} = 2.0 A, I _F = 5 mA, t < 1 s	_	45	70	mΩ
ON-state resistance (B connection)				—	22	35	
ON-state resistance (C connection)			I _{ON} = 4.0 A, I _F = 5 mA, t < 1 s	_	11	18	

Note 1: For an application circuit example, see Chapter 12.2.

10. Isolation Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Total capacitance (input to output)	Cs	(Note 1)	V _S = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	R _S	(Note 1)	V_S = 500 V, R.H. \leq 60 %	$5 imes 10^{10}$	10 ¹⁴	_	Ω
Isolation voltage	BVS	(Note 1)	AC, 60 s	1500	_	_	Vrms

Note 1: This device is considered as a two-terminal device: Pins 1, 2 and 3 are shorted together, and pins 4, 5 and 6 are shorted together.

11. Switching Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t _{ON}		See Fig. 11.1. R _L = 200 Ω, V _{DD} = 20 V, I _F = 5 mA	_	1.1	5.0	ms
			See Fig. 11.1. R _L = 200 Ω, V _{DD} = 20 V, I _F = 10 mA	_	0.6	3.0	
Turn-off time	t _{OFF}		See Fig. 11.1. R _L = 200 Ω, V _{DD} = 20 V, I _F = 5 mA	_	0.1	1.0	
			See Fig. 11.1. $R_L = 200 \ \Omega, V_{DD} = 20 \ V, I_F = 10 \ mA$	_	0.1	1.0	

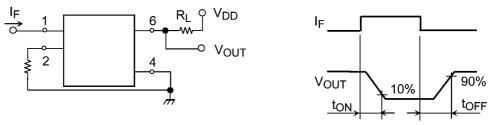


Fig. 11.1 Switching Time Test Circuit and Waveform

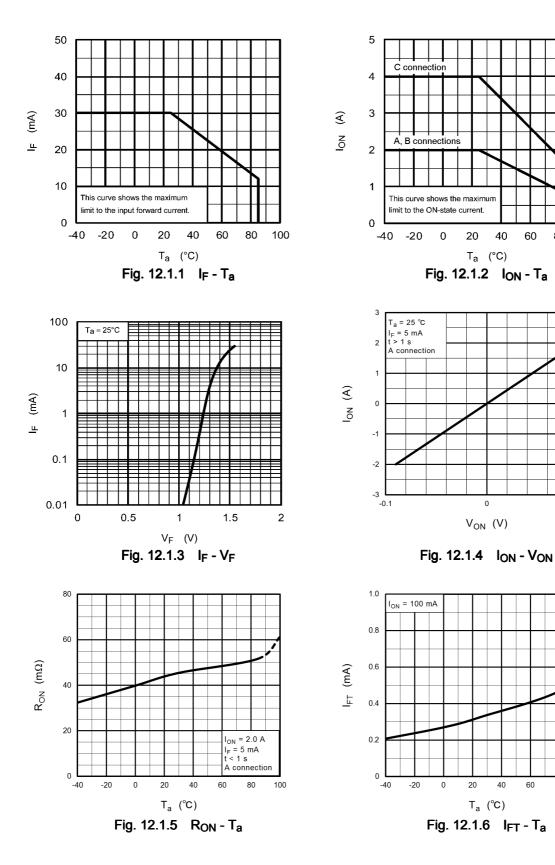
80

100

0.1

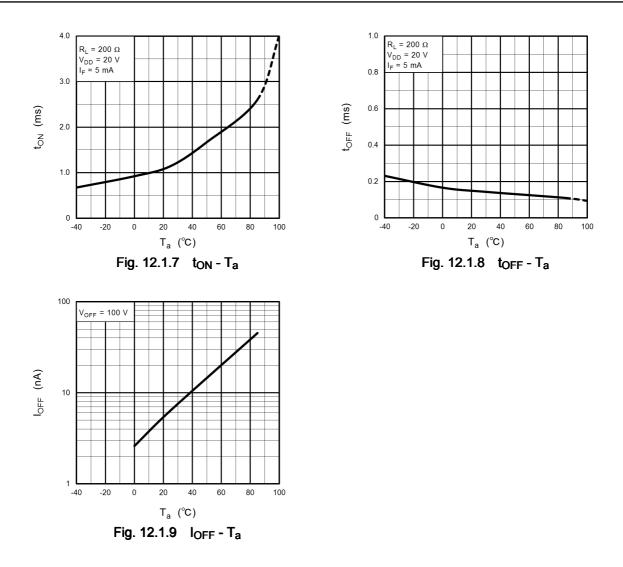
12. Characteristics Curves and Circuit Connections

12.1. Characteristics Curves (Note)



80

100



Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

12.2. Circuit Connections

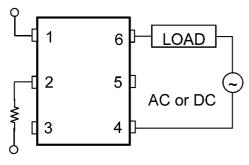


Fig. 12.2.1 A Connection

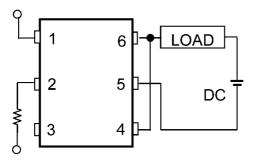


Fig. 12.2.3 C Connection

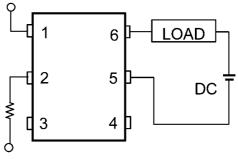
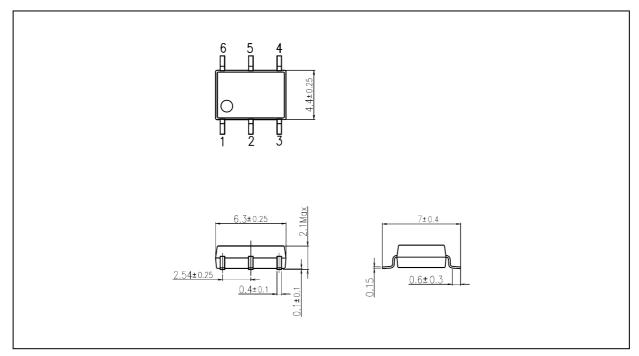


Fig. 12.2.2 B Connection

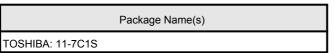
TLP3109

Package Dimensions

Unit: mm



Weight: 0.13 g (typ.)



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